## **TOSHIBA**

Unit: mm

TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type ( $L^2-\pi$ -MOSV)

# 2SJ377

Relay Drive, DC/DC Converter and Motor Drive Applications

- 4 V gate drive
- Low drain-source ON-resistance  $: R_{DS (ON)} = 0.16 \Omega (typ.)$
- High forward transfer admittance : |Y<sub>fs</sub>| = 4.0 S (typ.)
- Low leakage current :  $I_{DSS} = -100 \ \mu A \ (max) \ (V_{DS} = -60 \ V)$
- Enhancement mode : V<sub>th</sub> = -0.8~-2.0 V (V<sub>DS</sub> = -10 V, I<sub>D</sub> = -1 mA)

### Maximum Ratings (Ta = 25°C)

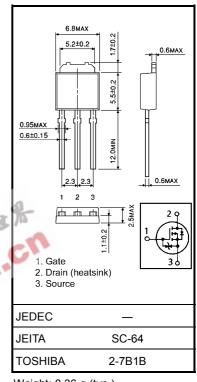
Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	-60	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	-60	V	
Gate-source voltage		V <sub>GSS</sub>	±20	. V -	
Drain current	DC (Note 1)	Ι <sub>D</sub>	-5	A	
	Pulse (Note 1)	I <sub>DP</sub>	-20	A	
Drain power dissipation (Tc = 25°C)		PD	20	W	
Single-pulse avalanche energy (Note 2)		E <sub>AS</sub>	273	mJ	
Avalanche current		I <sub>AR</sub>	-5	А	
Repetitive avalanche energy (Note 3)		EAR	2	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

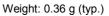
### **Thermal Characteristics**

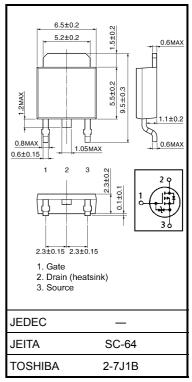
Characteristic	Symbol	Мах	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	6.25	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	125	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

- Note 2:  $V_{DD}$  = -25 V,  $T_{ch}$  = 25°C (initial), L = 14.84 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AR</sub> = -5 A
- Note 3: Repetitive rating: pulse width limited by maximum channel temperature
- This transistor is an electrostatic-sensitive device. Handle with care.







Weight: 0.36 g (typ.)

## <u>TOSHIBA</u>

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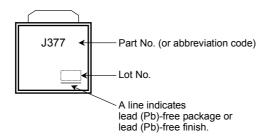
### Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Мах	Unit
Gate leakage cu	urrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	_	_	±10	μA
Drain cutoff curr	ent	I <sub>DSS</sub>	$V_{DS}$ = -60 V, $V_{GS}$ = 0 V	_		-100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = -10 mA, V <sub>GS</sub> = 0 V	-60	_	_	V
Gate threshold	voltage	V <sub>th</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-0.8		-2.0	V
Drain-source ON-resistance		R <sub>DS (ON)</sub>	V <sub>GS</sub> = -4 V, I <sub>D</sub> = -2.5 A		0.24	0.28	Ω
			$V_{GS}$ = -10 V, I <sub>D</sub> = -2.5 A	_	0.16	0.19	52
Forward transfe	r admittance	Y <sub>fs</sub>	$V_{DS}$ = -10 V, I <sub>D</sub> = -2.5 A	2.0	4.0	—	S
Input capacitant	ce	C <sub>iss</sub>		_	630	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = −10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	95	_	pF
Output capacitance		C <sub>oss</sub>			290	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{0V}{\longrightarrow} I_{D} = -2.5A$ $V_{GS} \stackrel{0V}{\longrightarrow} V_{OUT}$ $R_{L} = 12\Omega$ $V_{DD} = -30V$ $Duty \leq 1\%$ $t_{m} = 10/(s)$	_	25	_	
	Turn-on time	t <sub>on</sub>		_	45	_	ns
	Fall time	t <sub>f</sub>		2	55	_	
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , t <sub>w</sub> = $10\mu$ s		200	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	22	_	
Gate-source charge		Q <sub>gs</sub>	V <sub>DD</sub> ≈ −48 V, V <sub>GS</sub> = −10 V, I <sub>D</sub> = −5 A	_	16	_	nC
Gate-drain ("Miller") charge		Q <sub>gd</sub>		_	6	_	

### Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Мах	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	_	-5	A
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	_	_	-20	А
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = -5 A, V <sub>GS</sub> = 0 V	_	_	1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = -5 A, V <sub>GS</sub> = 0 V	—	80	—	ns
Reverse recovery charge	Qrr	$dI_{DR}$ / dt = 50 Å / $\mu$ S		0.1	_	μC

### Marking



## TOSHIBA

COMMON

SOUCE

-4

-3

-2

0

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ID

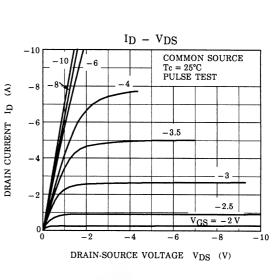
DRAIN CURRENT

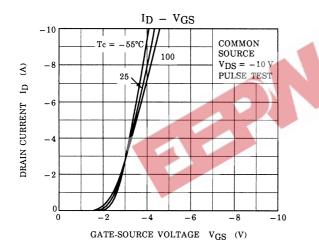
Tc = 25°C

PULSE TEST

-10

-0.4





 $I_D - V_{DS}$ 

- 6

-0.8

DRAIN-SOURCE VOLTAGE VDS (V)

- 4

-1.2

-3.5

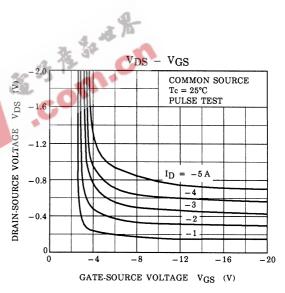
-3

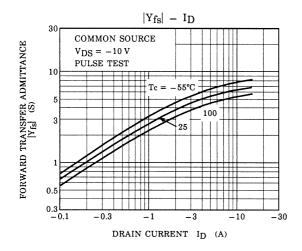
-2.5

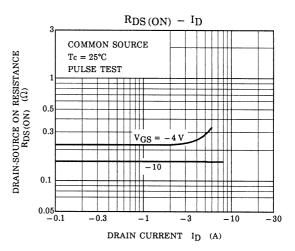
 $V_{GS} = -2 V$ 

-1.6

-2

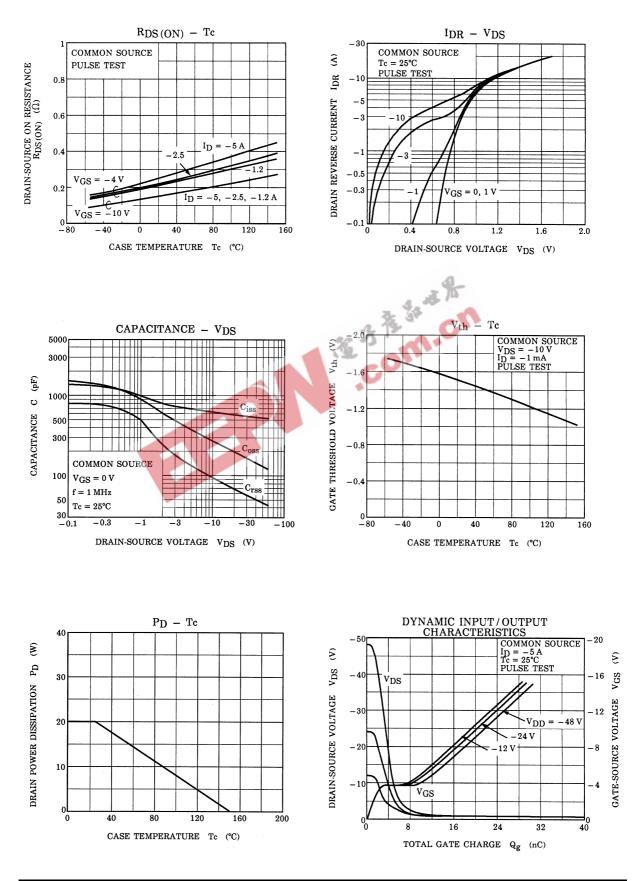






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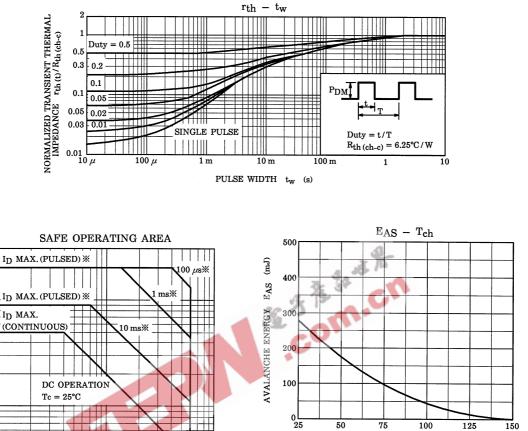
## <u>TOSHIBA</u>

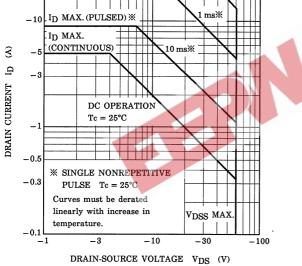


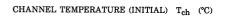
## TOSHIBA

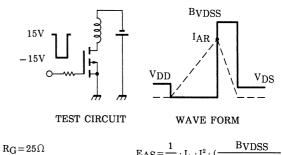
-30

NORMALIZED TRANSIENT THERMAL IMPEDANCE rth (t)/Rth (ch-c)









 $V_{DD} = -25V, L = 14.84mH$ 

 $E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot (\frac{B_{VDSS}}{B_{VDSS} - V_{DD}})$ 

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